STWA48N60DM2



N-channel 600 V, 0.065 Ω typ., 40 A MDmesh[™] DM2 Power MOSFET in a TO-247 long leads package

Datasheet - production data



Order code	VDS	RDS(on) max.	ID
STWA48N60DM2	600 V	0.079 Ω	40 A

- Fast-recovery body diode
- Extremely low gate charge and input capacitance
- Low on-resistance
- 100% avalanche tested
- Extremely high dv/dt ruggedness
- Zener-protected

Applications

Switching applications

Description

This high voltage N-channel Power MOSFET is part of the MDmeshTM DM2 fast recovery diode series. It offers very low recovery charge (Q_{rr}) and time (t_{rr}) combined with low $R_{DS(on)}$, rendering it suitable for the most demanding high efficiency converters and ideal for bridge topologies and ZVS phase-shift converters.

Table 1: Device summary

AM15572v1_no_tab

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TO-247 long leads

Figure 1: Internal schematic diagram

D(2)

S(3)

Order code	Marking	Package	Packing
STWA48N60DM2	48N60DM2	TO-247 long leads	Tube

G(1)

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This is information on a product in full production.

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1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
Vgs	Gate-source voltage	±25	V
1-	Drain current (continuous) at T _{case} = 25 °C	40	А
ID	Drain current (continuous) at T _{case} = 100 °C	25	A
IDM ⁽¹⁾	Drain current (pulsed)	160	А
Ртот	Total dissipation at $T_{case} = 25 \text{ °C}$	300	W
dv/dt ⁽²⁾	Peak diode recovery voltage slope	50	V/ns
dv/dt ⁽³⁾	MOSFET dv/dt ruggedness	- 50 V/ns	
T _{stg}	Storage temperature range	-55 to 150 °C	
Tj	Operating junction temperature range	-55 to 150 °C	

Notes:

 $^{\left(1\right) }$ Pulse width is limited by safe operating area

 $^{(2)}$ I_{SD} \leq 40 A, di/dt=900 A/µs; V_{DS} peak < V_(BR)DSS, V_{DD} = 400 V

 $^{(3)}$ V_{DS} \leq 480 V

Table 3: Thermal data

Symbol	Parameter		Unit
R _{thj-case}	Thermal resistance junction-case	0.42	
R _{thj-amb}	Thermal resistance junction-ambient	50	°C/W

Table 4: Avalanche characteristics

Symbol	Parameter		Unit
I _{AR}	Avalanche current, repetitive or not repetitive (Pulse width limited by T _{jmax})	7	А
E _{AR}	Single pulse avalanche energy (starting $T_j = 25 \text{ °C}$, $I_D = I_{AR}$, $V_{DD} = 50 \text{ V}$)	950	mJ



2 Electrical characteristics

(T_{case} = 25 °C unless otherwise specified)

Table 5: Static							
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit	
$V_{(BR)DSS}$	Drain-source breakdown voltage	$V_{GS} = 0 V$, $I_D = 1 mA$	600			V	
		V_{GS} = 0 V, V_{DS} = 600 V			1		
I _{DSS} Zero gate voltage drain current	$V_{GS} = 0 V, V_{DS} = 600 V,$ $T_{case} = 125 \ ^{\circ}C^{(1)}$			100	μA		
I _{GSS}	Gate-body leakage current	$V_{DS} = 0 V, V_{GS} = \pm 25 V$			±5	μA	
$V_{GS(th)}$	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	3	4	5	V	
RDS(on)	Static drain-source on-resistance	$V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}$		0.065	0.079	Ω	

Notes:

⁽¹⁾Defined by design, not subject to production test

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	3250	-	
Coss	Output capacitance	V _{DS} = 100 V, f = 1 MHz, ID = 0 A	-	142	-	pF
Crss	Reverse transfer capacitance	0 - 0 / 1	-	4.5	-	
C _{oss} eq. ⁽¹⁾	Equivalent output capacitance	$V_{DS} = 0$ to 480 V, $V_{GS} = 0$ V	-	258	-	pF
R _G	Intrinsic gate resistance	$f = 1 \text{ MHz}, I_D = 0 \text{ A}$	-	4	-	Ω
Qg	Total gate charge	$V_{DD} = 480 V, I_D = 40 A,$	-	70	-	
Qgs	Gate-source charge	V _{GS} = 10 V (see <i>Figure 14: "Test circuit</i>	-	18	-	nC
Q _{gd}	Gate-drain charge	for gate charge behavior")	-	28	-	

Table 6: Dynamic

Notes:

 $^{(1)}$ Coss $_{eq.}$ is defined as a constant equivalent capacitance giving the same charging time as Coss when VDs increases from 0 to 80% VDSs.



Electrical characteristics

_	Table 7: Switching times							
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit		
t _{d(on)}	Turn-on delay time	$V_{DD} = 300 \text{ V}, \text{ I}_{D} = 20 \text{ A}$	-	27	-			
tr	Rise time	$R_G = 4.7 \Omega, V_{GS} = 10 V$ (see Figure 13: "Test circuit	-	27	-			
t _{d(off)}	Turn-off delay time	for resistive load switching	-	131	-	ns		
t _f	Fall time	times" and Figure 18: "Switching time waveform")	-	9.8	-			

Table 8: Source-drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Isd ⁽¹⁾	Source-drain current		-		40	А
Isdm ⁽²⁾	Source-drain current (pulsed)		-		160	А
Vsd ⁽³⁾	Forward on voltage	V_{GS} = 0 V, I_{SD} = 40 A	-		1.6	V
trr	Reverse recovery time	I _{SD} = 40 A, di/dt = 100 A/µs,	-	140		ns
Qrr	Reverse recovery charge	V _{DD} = 60 V (see Figure 15: "Test circuit for	-	0.7		μC
I _{RRM}	Reverse recovery current	inductive load switching and diode recovery times")	-	10		А
t _{rr}	Reverse recovery time	I _{SD} = 40 A, di/dt = 100 A/µs,	-	256		ns
Qrr	Reverse recovery charge	$V_{DD} = 60 \text{ V}, \text{ T}_{j} = 150 ^{\circ}\text{C}$ (see <i>Figure 15: "Test circuit for</i>	-	2.5		μC
Irrm	Reverse recovery current	inductive load switching and diode recovery times")	-	20		A

Notes:

⁽¹⁾Limited by maximum junction temperature

 $^{\left(2\right) }$ Pulse width is limited by safe operating area.

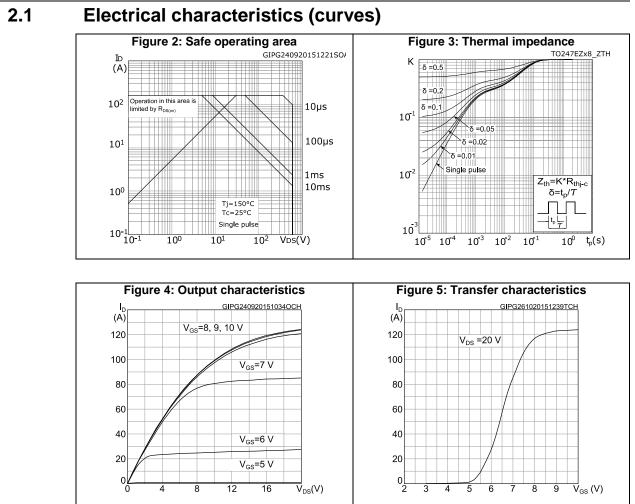
 $^{(3)}$ Pulse test: pulse duration = 300 µs, duty cycle 1.5%.

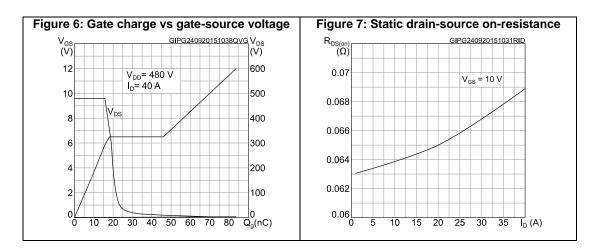
Table 9: Gate-source Zener diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _(BR) GSO	Gate-source breakdown voltage	I_{GS} = ±250 µA, I_D = 0 A	±30	-	-	V

The built-in back-to-back Zener diodes are specifically designed to enhance the ESD performance of the device. The Zener voltage facilitates efficient and cost-effective device integrity protection, thus eliminating the need for additional external componentry.







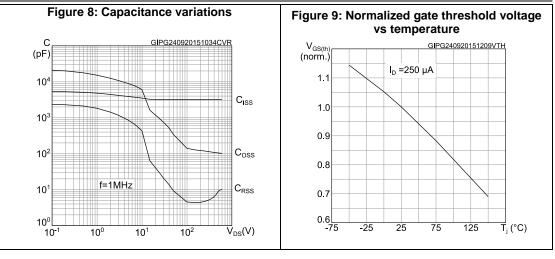


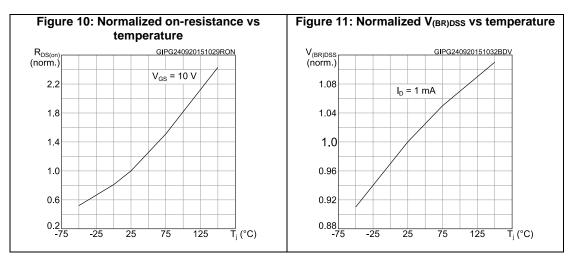


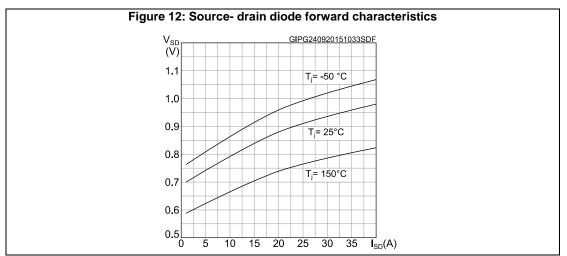
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Electrical characteristics

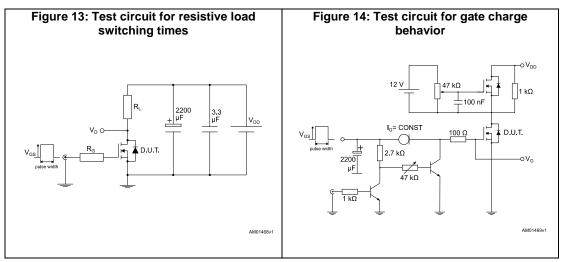


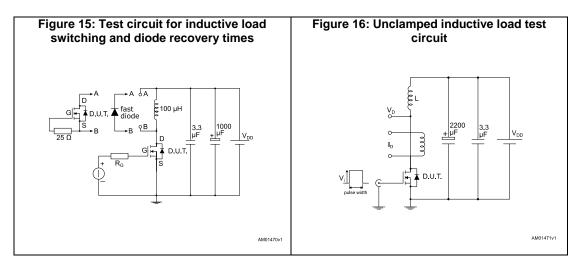


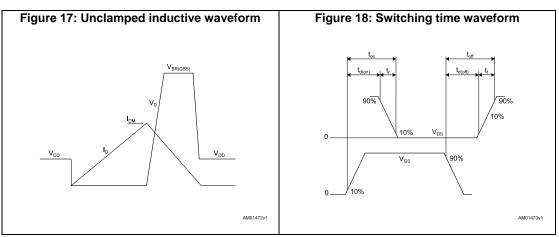


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3 Test circuits







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4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.

4.1 TO-247 long leads package information

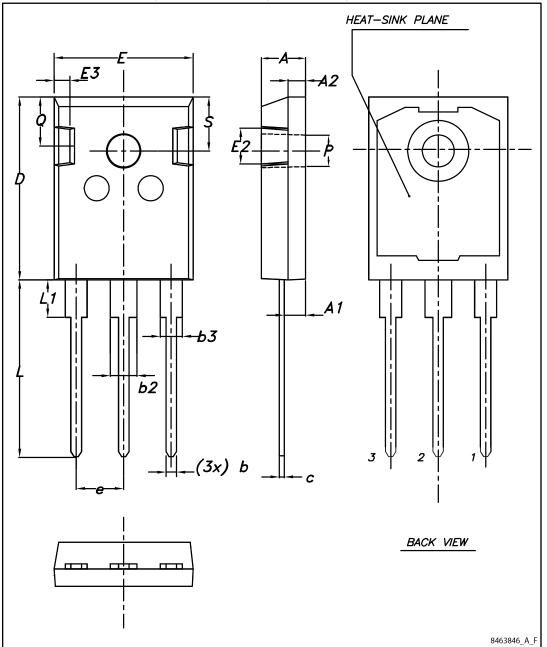


Figure 19: TO-247 long leads package outline



Package information

STWA48N60DM2

Table 10: TO-247 long leads package mechanical data					
Dim.		mm			
Dini.	Min.	Тур.	Max.		
А	4.90	5.00	5.10		
A1	2.31	2.41	2.51		
A2	1.90	2.00	2.10		
b	1.16		1.26		
b2			3.25		
b3			2.25		
С	0.59		0.66		
D	20.90	21.00	21.10		
E	15.70	15.80	15.90		
E2	4.90	5.00	5.10		
E3	2.40	2.50	2.60		
е	5.34	5.44	5.54		
L	19.80	19.92	20.10		
L1			4.30		
Р	3.50	3.60	3.70		
Q	5.60		6.00		
S	6.05	6.15	6.25		



5 Revision history

Table 11: Document revision history

Date	Revision	Changes
20-Dec-2016	1	First release



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